# LITEON LITE-ON TECHNOLOGY CORP. APPROVAL SHEET

CUSTOMER : ASUS

CUSTOMER NO : 0A001-00095900

MODEL NO : PA-1050-39

PRODUCT NO: PA-1050-39U3 Rev.A03

**ISSUE DATE** : 2017/07/19

Customer Approved By:

## LITE-ON TECHNOLOGY CORP(光寶科技股份有限公司)

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## Subject: Revision Records For Approval Sheet.

Model:	PA-1050-39U3

Customer Revision	Revision	Date	Comments Description.	DCN No.
NA	A01	07/29/16	Initial	
NA	A02	4/14/17	Change OPP to BOPP	DCN1703150
NA	A03	7/19/17	Apply BSMI ROHS New Rule	DCN1706099
				1



## **ENGINEERING SPECIFICATION**

5W AC Charger

Part Number: PA-1050-39U3

Product Rev: A

Customer	Rev.	Written By	Effective Date	LITE-ON Technology Corp.
ASUS	Α	Jeff Hsu	2016/06/22	SHEET 1 of 11
				LTADPDOC-001-0B1



## **Revision History**

REV.A, 2016.06.22 -Modify from PA-1050-39UW.

Customer	Rev.	Written By	Effective Date	LITE-ON Technology Corp.
ASUS	А	Jeff Hsu	2016/06/22	SHEET 2 of 11
				LTADPDOC-001-0B1



## **Table Contents**

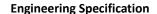
1.	Ge	neral	5
	1.1.	SCOPE	5
2.	INF	PUT REQUIREMENTS	5
	2.1.	INPUT VOLTAGE	
	2.2.	FREQUENCY	
	2.3.	Voltage Section	
	2.4.	Efficiency & Energy Star Requirement	
	2.5.	Input Current	
	2.6.	Inrush Current	
	2.7.	POWER SUPPLY EFFICIENCY	5
	2.8.	Output Load Ripple Current	6
3.	OU	TPUT REQUIREMENTS	6
-	3.1.	STATIC DC LOAD	
	3.2.	DYNAMIC LOAD	
	3.3.	TURN ON DELAY TIME	
	3.4.	RISE TIME	
	3.5.	RIPPLE AND NOISE	
	3.6.	LOAD IMPEDANCE	
	3.7.	HOLD UP TIME	7
	3.8.	Overshoot	7
			_
4.	NO	LOAD OPERATION	/
		LOAD OPERATION	
4. 5.	PR	OTECTION	7
	<b>PR</b> (5.1.	OTECTION	7 7
	<b>PR</b> (5.1. 5.2.	OVER VOLTAGE PROTECTIONSHORT CIRCUIT PROTECTION	7 7 7
5.	<b>PR</b> (5.1. 5.2. 5.3.	OTECTION  OVER VOLTAGE PROTECTION  SHORT CIRCUIT PROTECTION  OVER CURRENT PROTECTION	7 7 7
5.	PR0 5.1. 5.2. 5.3.	OTECTION  OVER VOLTAGE PROTECTION  SHORT CIRCUIT PROTECTION  OVER CURRENT PROTECTION  FETY REQUIREMENTS	7 7 8
5.	5.1. 5.2. 5.3. SAI 6.1.	OTECTION  OVER VOLTAGE PROTECTION  SHORT CIRCUIT PROTECTION  OVER CURRENT PROTECTION  FETY REQUIREMENTS  DIELECTRIC STRENGTH	7 7 8 8
5.	5.1. 5.2. 5.3. <b>SAI</b> 6.1. 6.2.	OVER VOLTAGE PROTECTION. SHORT CIRCUIT PROTECTION. OVER CURRENT PROTECTION.  FETY REQUIREMENTS DIELECTRIC STRENGTH INSULATION RESISTANCE	7 7 8 8
5.	5.1. 5.2. 5.3. SAI 6.1.	OTECTION  OVER VOLTAGE PROTECTION  SHORT CIRCUIT PROTECTION  OVER CURRENT PROTECTION  FETY REQUIREMENTS  DIELECTRIC STRENGTH	7 7 8 8
5.	5.1. 5.2. 5.3. SAI 6.1. 6.2. 6.3.	OVER VOLTAGE PROTECTION. SHORT CIRCUIT PROTECTION. OVER CURRENT PROTECTION.  FETY REQUIREMENTS DIELECTRIC STRENGTH INSULATION RESISTANCE	7 7 8 8
5. 6.	5.1. 5.2. 5.3. SAI 6.1. 6.2. 6.3.	OVER VOLTAGE PROTECTION SHORT CIRCUIT PROTECTION OVER CURRENT PROTECTION  FETY REQUIREMENTS DIELECTRIC STRENGTH INSULATION RESISTANCE GROUND LEAKAGE CURRENT	7 7 8 8 8
5. 6.	PR6 5.1. 5.2. 5.3. SAI 6.1. 6.2. 6.3.	OVER VOLTAGE PROTECTION. SHORT CIRCUIT PROTECTION. OVER CURRENT PROTECTION.  FETY REQUIREMENTS. DIELECTRIC STRENGTH. INSULATION RESISTANCE. GROUND LEAKAGE CURRENT.	7 7 8 8 8
5. 6.	PR6 5.1. 5.2. 5.3. SAI 6.1. 6.2. 6.3. ELE 7.1.	OVER VOLTAGE PROTECTION. SHORT CIRCUIT PROTECTION. OVER CURRENT PROTECTION.  FETY REQUIREMENTS. DIELECTRIC STRENGTH. INSULATION RESISTANCE. GROUND LEAKAGE CURRENT.  CCTROMAGNETIC COMPATIBILITY FCC REQUIREMENTS.	7 7 8 8 8 8
5. 6.	PR6 5.1. 5.2. 5.3. SAI 6.1. 6.2. 6.3. ELE 7.1. 7.2.	OVER VOLTAGE PROTECTION SHORT CIRCUIT PROTECTION OVER CURRENT PROTECTION  FETY REQUIREMENTS DIELECTRIC STRENGTH INSULATION RESISTANCE GROUND LEAKAGE CURRENT  FCC REQUIREMENTS. VDE REQUIREMENTS.	7 7 8 8 8 8
5. 6.	5.1. 5.2. 5.3. SAI 6.1. 6.2. 6.3. ELE 7.1. 7.2. 7.3.	OVER VOLTAGE PROTECTION SHORT CIRCUIT PROTECTION OVER CURRENT PROTECTION  ETTY REQUIREMENTS DIELECTRIC STRENGTH INSULATION RESISTANCE GROUND LEAKAGE CURRENT  CTROMAGNETIC COMPATIBILITY FCC REQUIREMENTS VDE REQUIREMENTS VCCI REQUIREMENTS EMC REQUIREMENTS	7 7 8 8 8 8
5. 6.	PR6 5.1. 5.2. 5.3. SAI 6.1. 6.2. 6.3. ELE 7.1. 7.2. 7.3. 7.4.	OVER VOLTAGE PROTECTION SHORT CIRCUIT PROTECTION OVER CURRENT PROTECTION  ETY REQUIREMENTS DIELECTRIC STRENGTH INSULATION RESISTANCE GROUND LEAKAGE CURRENT  CTROMAGNETIC COMPATIBILITY  FCC REQUIREMENTS. VDE REQUIREMENTS VCCI REQUIREMENTS  VCCI REQUIREMENTS  EMC REQUIREMENTS  I Immunity requirement	7 7 8 8 8 8 8
5. 6.	5.1. 5.2. 5.3. SAI 6.1. 6.2. 6.3. ELE 7.1. 7.2. 7.3. 7.4.	OVER VOLTAGE PROTECTION SHORT CIRCUIT PROTECTION OVER CURRENT PROTECTION  FETY REQUIREMENTS DIELECTRIC STRENGTH INSULATION RESISTANCE GROUND LEAKAGE CURRENT  CCTROMAGNETIC COMPATIBILITY FCC REQUIREMENTS. VDE REQUIREMENTS VCCI REQUIREMENTS VCCI REQUIREMENTS EMC REQUIREMENTS  1. Immunity requirement 1. Immunity requirement 1. Emissions requirement 1. Power line Harmonics	7 7 8 8 8 8 8 8 8
5. 6.	PR6 5.1. 5.2. 5.3. SAI 6.1. 6.2. 6.3. ELE 7.1. 7.2. 7.3. 7.4.	OVER VOLTAGE PROTECTION SHORT CIRCUIT PROTECTION OVER CURRENT PROTECTION  ETY REQUIREMENTS DIELECTRIC STRENGTH INSULATION RESISTANCE GROUND LEAKAGE CURRENT  CCTROMAGNETIC COMPATIBILITY  FCC REQUIREMENTS. VDE REQUIREMENTS VCCI REQUIREMENTS  VCCI REQUIREMENTS EMC REQUIREMENTS  1. Immunity requirement 1. Immunity requirement 1. Emissions requirement 1. Power line Harmonics	7 7 8 8 8 8 8 8 8 9

Customer	Rev.	Written By	Effective Date	LITE-ON Technology Corp.
ASUS	Α	Jeff Hsu	2016/06/22	SHEET 3 of 11
				LTADPDOC-001-0B1



7.6.	LIGHTNING SURGE	9
7.7.	ESD	9
7.8.	Common Noise	9
8. RI	ELIABILITY	9
8.1.	MTBF	
8.2.	OPERATION LIFE	
9. EN	NVIROMENT	10
9.1.	OPERATING	10
9.2.	SHIPPING AND STORAGE	10
9.3.	Altitude	10
9.4.	Regulated Substances REQUIREMENT	10
10. TE	EMPERATURE RISE OF CASE SURFACE	10
11. A	coustic noise	10
12. I	Drop Test	10
13.	AC Plug Pull/Push Test	10
14. M	IACHANICAL	11
14.1.	Physical Size	11
14.2.	Input Connector	11
14.3.	Output Connector	

Customer	Rev.	Written By	Effective Date	LITE-ON Technology Corp.
ASUS	A	Jeff Hsu	2016/06/22	SHEET 4 of 11
				LTADPDOC-001-0B1





#### 1. General

#### 1.1.SCOPE

This specification defines the performance characteristics of a grounded single phase, 5watt, 5.2Vdc output power supply. This specification also defines worldwide safety and electromagnetic compatibility requirements for the power supply which is intended for use in USB device charger.

#### 2. INPUT REQUIREMENTS

#### 2.1. INPUT VOLTAGE

	MINIMUM	MAXIMUM	NOMINAL
LOW RANGE	90VAC	132VAC	100-120VAC
HIGH RANGE	180VAC	264VAC	200-240VAC

#### 2.2. FREQUENCY

	MINIMUM	MAXIMUM	NOMINAL
SINGLE PHASE	47Hz	63Hz	50-60Hz

#### 2.3. Voltage Section

A full range will be provided to select the appropriate range.

#### 2.4. Efficiency & Energy Star Requirement

The Adaptor shall be designed to meet EPS Requirement as below for both 115VAC and 230VAC:

- a. No Load Average Power Loss shall be less than **75mW** at 230Vac/ 50Hz.
- b. When Output load is **0.25W**, input watt shall be less than **0.45W**.
- c. Average Efficiency value of 25%, 50%, 75%, 100% load condition shall be higher **73.7%** at input voltage 115Vac/60Hz and 230Vac/50Hz . with a 1A load condition
- d. The 10% load condition shall be higher **60.7%** at input voltage 115Vac/60Hz and 230Vac/ 50Hz

#### 2.5. Input Current

**0.25** Amps maximum at nominal input voltage within the low range as specified in paragraph 2.1 and at any combination of loading conditions.

#### 2.6. Inrush Current

Peak inrush current: Inrush current shall not exceed 22% of the max rated value including I2t derating for all input components.

#### 2.7. POWER SUPPLY EFFICIENCY

-The power supply efficiency shall be more than 70% measure at the normal voltage maximum load as specified in paragraph 2.2.1 with the AC input set at the nominal voltage. The power supply efficiency shall meet requirement as specified in item 2.4 with

Customer	Rev.	Written By	Effective Date	LITE-ON Technology Corp.
ASUS	А	Jeff Hsu	2016/06/22	SHEET 5 of 11
				LTADPDOC-001-0B1



the AC input set at the nominal voltage.

## 2.8. Output Load Ripple Current

<100mA

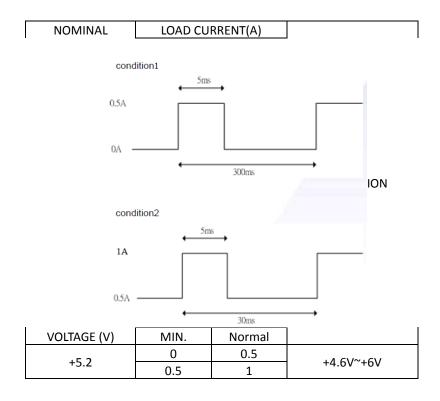
## 3. OUTPUT REQUIREMENTS

#### 3.1. STATIC DC LOAD

l	NOMINAL	LOA	DECLU ATION		
	VOLTAGE (V)	MIN. Normal Max.		REGULATION	
	+5.2	-		1	+5V~+5.25V
	+5.2	0		-	+4.94V~+5.25V

Note: Output added 0.1uF ceramic capacitor and 10uF tantalum capacitor capacitors.

#### 3.2. DYNAMIC LOAD



Note1. If output drop less than 4.6V, the durning shall less than 3ms @ condition 1.

#### 3.3. TURN ON DELAY TIME

The output turn on delay time (time from the application of AC to output within regulation limits) shall be less than **3s at 100V/ 240V and maximum output load.** 

#### 3.4. RISE TIME

The output rise time (measured from the 10% point to the 90% point on the waveform) shall be less than **40ms**.

Customer	Rev.	Written By	Effective Date	LITE-ON Technology Corp.
ASUS	А	Jeff Hsu	2016/06/22	SHEET 6 of 11
				LTADPDOC-001-0B1



#### 3.5. RIPPLE AND NOISE

The ripple and noise of the outputs shall be measured at the load end if the output cables when terminated to load impedance as specified in paragraph 3.1

OUTPUT V	RIPPLE & NOIS	E (P-P)	Output Load			
+5.2	V	200	\/	1		
+5.2	V	100	mV	0.5	А	

- 1. Use 20MHz Bandwidth frequency scope.(sample mode)
- 2. Output added 0.1uF ceramic capacitor and 10uF tantalum capacitor capacitors.

#### 3.6. LOAD IMPEDANCE

Filter capacitors are connected to each pins of the mating output connector. Capacitance values and material type are listed below.

VOLTAGE NOM.(V)	CAPACITANCE NOM. (uF)	MATERIAL TYPE
+5.2V	0.1uF/10uF	CERAMIC/TAN

#### 3.7. HOLD UP TIME

The power supply shall maintain voltage regulation within the specified limits in paragraph 3.1 for at least **5** milliseconds after lost of input voltage measure at 100 VAC(rms) and at maximum output load.

#### 3.8. Overshoot

-The output overshoot at turn on shall not exceed 10% of normal voltage value with or without the load connected.

#### 4. NO LOAD OPERATION

The power supply shall be able to operate under no load condition. No damage to the power supply is allowed and internal component cannot be stressed beyond its rating

#### 5. PROTECTION

#### 5.1. OVER VOLTAGE PROTECTION

The power supply should shutdown for any cause of over voltage conditions before any output exceeds its limits below.

NOMINAL OUTPUT	OVER VOLTAGE
VOLTAGE (V)	MAX.
+5.2	7.5V

The power supply will be auto-recovery or latch when OVP function is triggered..

#### 5.2. SHORT CIRCUIT PROTECTION

Customer	Rev.	Written By	Effective Date	LITE-ON Technology Corp.			
ASUS	А	Jeff Hsu	2016/06/22	SHEET 7 of 11			
			•	LTADPDOC-001-0B1			



A short circuit placed on DC output shall cause no damage and auto-recovery.

#### 5.3. OVER CURRENT PROTECTION

The power supply shall provide over current protection on output. Maximum current inception point of output shall be limited to the following values:

OUTPUT VOLTAGE (V)	CURRENT LIMIT (A)
+5.2	1.22A

The power supply output establish again within 2s after overload is removed.

The power supply can't has any damage during working at CC mode.

#### 6. SAFETY REQUIREMENTS

The power supply must comply with the following national standards:

#### 6.1. DIELECTRIC STRENGTH

Primary to Secondary: 4242 VDC or 300Vac for 60sec.

#### 6.2. INSULATION RESISTANCE

Primary to secondary: 30 Meg. ohms Min., 500VDC

#### 6.3. GROUND LEAKAGE CURRENT

The power supply ground leakage current shall be less than 20 uA at 240Vac/ 50Hz.

#### 7. ELECTROMAGNETIC COMPATIBILITY

Power supply for use with the host system will be tested to conform with the following emission standards.

#### 7.1. FCC REQUIREMENTS

Power supply shall comply with the United States Communication Commission (FCC) Rules and Regulations, Part 15, Subpart J, Computing Devices "Class B limits".

#### 7.2. VDE REQUIREMENTS

Power supply shall conform to the "Class B" requirements of CISPR 22.

#### 7.3. VCCI REQUIREMENTS

Power supply shall conform to the "Class II" requirements of VCCI.

#### 7.4. EMC REQUIREMENTS

#### 7.4.1. Immunity requirement

The adapter shall meet the below Immunity requirement based on:

Customer	Rev.	Written By	Effective Date	LITE-ON Technology Corp.
ASUS	Α	Jeff Hsu	2016/06/22	SHEET 8 of 11
				LTADPDOC-001-0B1

## **LITEO**N®

#### **Engineering Specification**

- 1. IEC 61000-4.2 ESD
- 2. IEC 61000-4.3 Radiated Immunity
- 3. IEC 61000-4.4 Electrical Fast Transients
- 4. IEC 61000-4.5 Surges
- 5. IEC 61000-4.6 Conducted Immunity
- 6. IEC 61000-4.11Voltage Dips
- 7.4.2. Emissions requirement

The adapter shall meet EN55022 Class B

7.4.3. Power line Harmonics

The adapter shall meet IEC 1000-3-2 Class D

7.4.4. Voltage Fluctuation and Flicker
The adapter shall meet EN610003-3

#### 7.5. IMPULSE NOISE

A ±1K volt

#### 7.6. LIGHTNING SURGE

A ±1K volt (L-N) by IEC 61000-4-5

#### 7.7. ESD

this adapter is capable to withstand ESD Test voltage at any point around The enclosure as below.

±15KV air discharge Performance Criterion B

±12KV air discharge Performance Criterion A.

±8KV contact discharge Performance Criterion A.

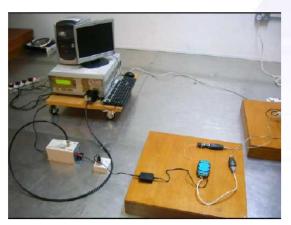
#### 7.8. Common Noise

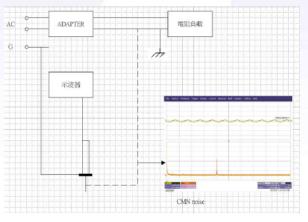
Test Equipment and Environment: Follow EN61000-4-6

Test voltage Condition :3V

Test Frequency:150K ~ 600KHz

Specification :CMN Max.:0.8V @150K~600K





## 8. RELIABILITY

Customer	Rev.	Written By	Effective Date	LITE-ON Technology Corp.
ASUS	А	Jeff Hsu	2016/06/22	SHEET 9 of 11
				LTADPDOC-001-0B1

## LITEON®

#### **Engineering Specification**

#### 8.1. MTBF

The PSU Mean Time Between Failures should not less than 150K hours at 100/240Vac 90% load 25 degree C.

#### 8.2. OPERATION LIFE

The Adaptor shall be designed for a min. life of 13140hrs at 5W load condition, ambient temperature at 25 degree C, input voltage at 100Vac and 240Vac.

Note: Capacitor voltage 95% de-rating is accepted.

#### 9. ENVIROMENT

#### 9.1. OPERATING

Temperature: 0 to 40 degrees centigrade.

Relative Humidity: 5 to 95 percent RH, non-condensing.

#### 9.2. SHIPPING AND STORAGE

Temperature: -30 to +80 degrees centigrade.

Relative Humidity: 5 to 95 percent RH, non-condensing.

#### 9.3. Altitude

Operation: 0-10,000ft Shipping: 0-50,000ft

#### 9.4. Regulated Substances REQUIREMENT

The Adaptor shall be designed to meet 100% RoHS requirement.

#### 10. TEMPERATURE RISE OF CASE SURFACE

The case temperature rice shall be less than 60deg C at 25deg C ambient 100/ 240Vac on Bakelite without airflow. ( $\Delta$  T < 35°C at 25°C) (It doesn't include the bottom surface)

#### 11. Acoustic noise

Input Condition: Vin: 90Vac~264Vac

Frequency: 47Hz to 63 Hz

Load Condition:

Dynamic Load follows ASUS Spec

Static Load (from 0A to Full Load, 0.05A per step) Spec.

Static Load:

Microphone at a distance of 10cm from the surface and noise level is less than 20dB Microphone at a distance of 3cm from the surface and noise level is less than 25dB

#### 12. Drop Test

Drop 30 times(5 times on each face) on each cycles from a height of 36 inches onto a hardwood surface. There must be no function damage after testing

#### 13. AC Plug Pull/Push Test

After welding push or plug 30Kg force on AC Plug, the AC plug can't

Customer	Rev.	Written By	Effective Date	LITE-ON Technology Corp.
ASUS	А	Jeff Hsu	2016/06/22	SHEET 10 of 11
				LTADPDOC-001-0B1



separated from the main body and case can't deformation .

## 14. MACHANICAL

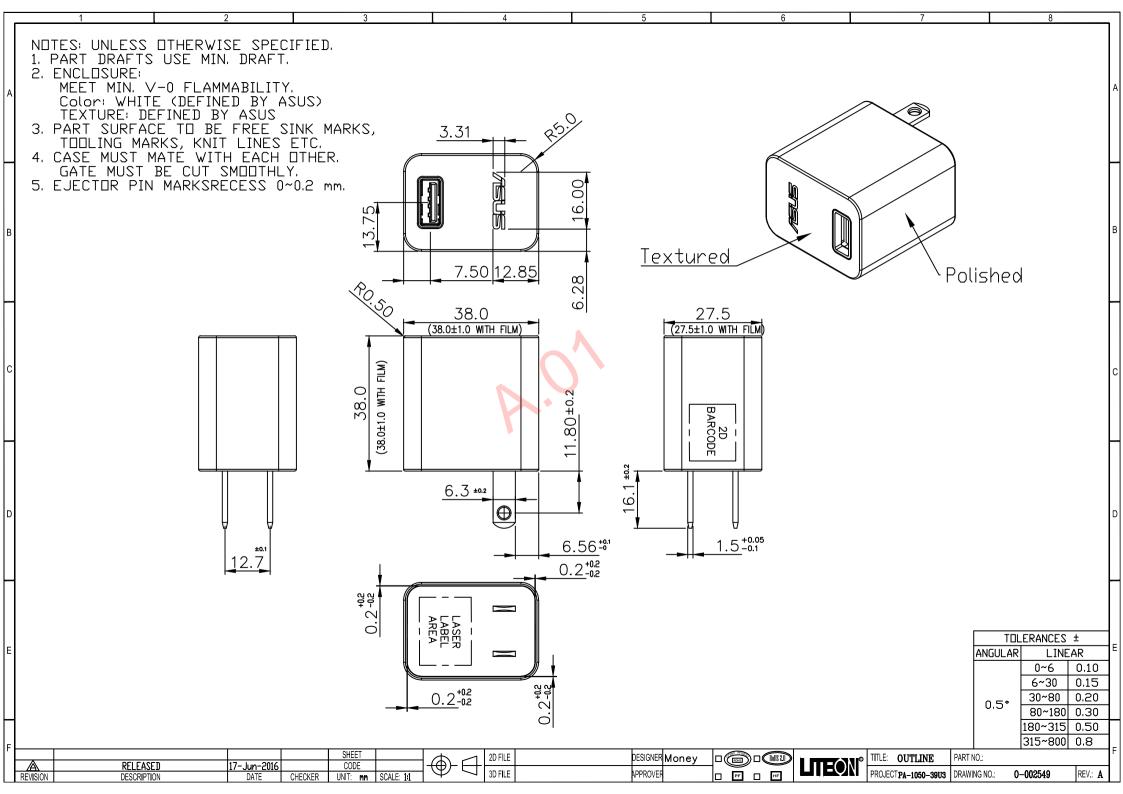
14.1. Physical Size

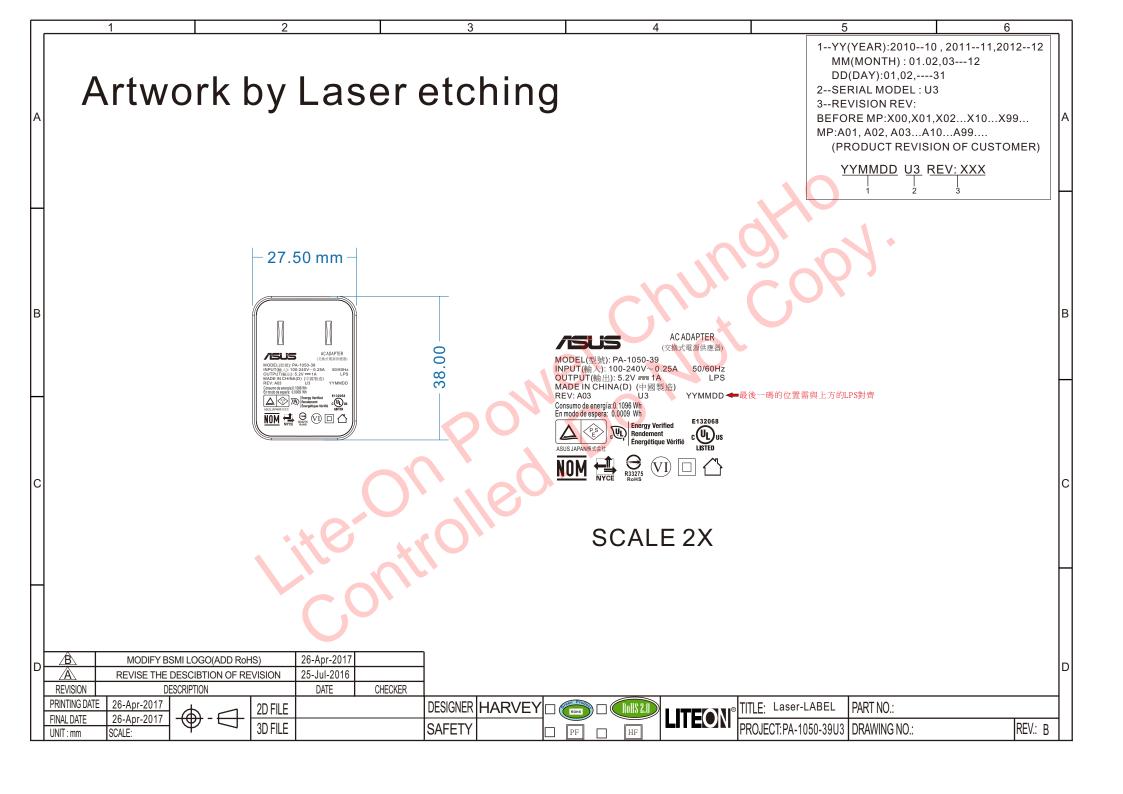
Plastic case size 38mm (L)\* 38mm (W) \*27.5mm(H)

Weight: 31 g ± 2.5%
14.2. Input Connector
Input Pin: US PIN

14.3. Output Connector USB 2.0 connector

Customer	Rev.	Written By	Effective Date	LITE-ON Technology Corp.
ASUS	А	Jeff Hsu	2016/06/22	SHEET 11 of 11
				LTADPDOC-001-0B1





## NOTES

- 1.Material and specification please refer to P/N:825172
- 2D barcode printing rule as below definition.

## 2D BARCODE DEFINITION:

PPPP-PPPPPPYWWFXXXXX

PART NO.: ASUS P/N

YEAR CODE:

EX:2014 YEAR :PRINT 4

WFFK CODF: FROM 01~52 EX:10TH WEEK, PRINT 10

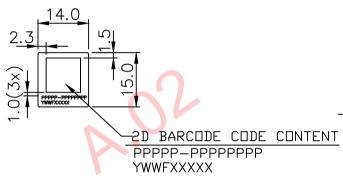
FACTORY CODE: FROM A TO Z

EX:CZ PLANT PRINT AS D

SERIES NUMBER FROM 00001~ZZZZZ FOR EVERY WEEK.THIS STARTING SERIAL NO.WILL ALWAYS BEGIN AT"00001".

1	PA-1050-39U3	0A001-00094500
ITEM	LITEON MODEL	ASUS PART NO.

2D BARCODE PRINT RULE PRINTED BY LITEON

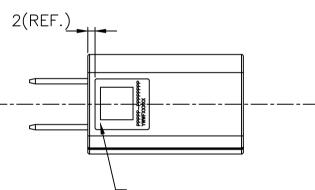


A. 字體顏色:黑色(Defined by ASUS)

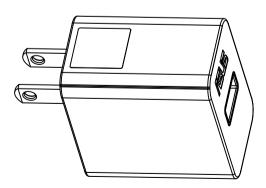
BARCODE碼大小:8.0\*8.0mm 文字部分:Arial(字高 1.4mm)

- B. 2D BARCODE
  - \* 600 DPI Printer Minimum.
  - \* 24X24 row/column Datamatrix ECC200 symbol per ISO/IEC 16022 Data Matrix Specification 20 mil cell dimension.
- \* Color:BLACK(Defined by ASUS)

2D BARCODE STICK LOCATION



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